



# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

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Title of Invention	SEEDLESS WIREBOND PAD PLATING
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Application Number : 10 / 707, 075

Confirmation Number:

First Named Applicant: Chandrasekhar Narayan

Attorney Docket Number: FIS920030226US1

Art Unit: 2811

Examiner: Jung hwa Im

Search string: ( 6534863 or 6368484 or 5804464 or 5670428 or 5313158 or 4956602 ).pn

## US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
1	1	6534863	2003-03-18	Walker, et al.			
	2	6368484	2002-04-09	Valant, et al.			
	3	5804464	1998-09-08	Beilstein, Jr., et al.			
	4	5670428	1997-09-23	Beilstein, Jr., et al.			
	5	5313158	1994-05-17	Joosten, et al.			
↓	6	4956602	1990-09-11	Parrish			

## Signature

Examiner Name	Date
Jung hwa Im	10/03/2005